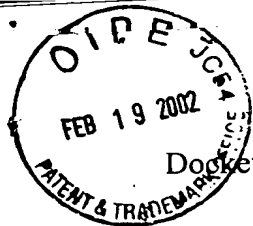


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Docket No.: 1999P1778

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Andreas Kux et al.
Applic. No. : 10/002,925
Filed : November 2, 2001
Title : Method and Device for Securing a Multi-Dimensionally constructed
Chip Stack and Chip Configuration
Attention : Office of Petitions

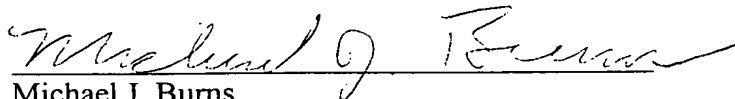
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OFFICE OF PETITIONS

DECLARATION
TO ACCOMPANY PETITION UNDER 37 C.F.R. 1.10(c)

I, Michael J. Burns, hereby declare that:

- ❖ I have first-hand knowledge that the above-identified application was sent by Express Mail to the Patent and Trademark Office on November 2, 2001.
- ❖ I personally signed the mailing certificate on the cover sheet which accompanied the new US application.
- ❖ I have reviewed the pertinent pages of the outgoing mail log for November 2, 2001, and the pages show that the enclosed papers were indeed mailed by Express Mail on that date.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.


Michael J. Burns

Date: December 24, 2001